

## AC/DC Secondary-Side Controller with Integrated Synchronous Rectification for USB PD 3.0 w/PPS and Qualcomm<sup>®</sup> Quick Charge<sup>™</sup> 4+ (QC2.0/QC3.0/QC4)

#### **1 Description**

The iW709 is an AC/DC secondary-side controller for USB Power Delivery (PD) 3.0 with Programmable Power Supply (PPS) and Qualcomm<sup>®</sup> Quick Charge<sup>™</sup> QC4+ (QC2.0/QC3.0/QC4) support which integrates a secondary-side regulation controller, interface protocol controller, USB V<sub>BUS</sub> driver and synchronous rectifier controller into a single IC.

The iW709 allows rapid charge of USB PD PPS or QC-enabled mobile devices (MDs). It resides on the secondary side of an AC/DC travel adapter (TA) and allows the TA to be configured for multi-level output voltage and current.

The iW709 measures the output voltage and load current and sends the results to a digital compensator for closed-loop control of flyback converter. The digital control signal generated by the compensator is converted to an analog signal and transferred to primary controller via an optocoupler.

The iW709 is also an advanced synchronous rectifier (SR) controller with an integrated MOSFET driver. The device works with an external power MOSFET to replace the main rectifying diode on the secondary of a flyback converter. The SR control block optimizes the SR on/off timing and also uses proprietary technologies for timing control of ZVS or active clamp flyback topologies to achieve best efficiency when coupled with Dialog's ZVS-enabled primary-side controllers.

The iW709 can be paired with one of Dialog's high-performance flyback controllers that support either quasi-resonant (QR) control or QR and Zero Voltage Switching (ZVS) technology to achieve high efficiency, low no-load power consumption, accuracy voltage/current control and fast dynamic load response.

#### 2 Features

- USB-IF certified: USB PD 3.0 with PPS
  - » Supports 3.3V to 21V in 20mV steps and output current in 50mA steps
- Optionally supports Qualcomm QC4+ (QC2.0/QC3.0/QC4)
- High resolution accuracy multi-level output voltage and current control
- Built-in digital loop compensation to minimize the external component count
- Built-in synchronous rectification controller with integrated driver
- Optimized V<sub>DS</sub>-based SR timing and driving control for
  ZVS or active clamp flyback with wide output range

### **3 Applications**

• Direct-charge AC/DC adapters for USB PD enabled smart phones, tablets and other mobile devices

- NFET driver for  $V_{BUS}$  switch
- Programmable active fast discharge from a high voltage to 5V at MD unplug or from a high voltage level to a lower level upon request with built-in switch or external switch
- Intelligent low power mode enables very low no-load power consumption when paired with one of Dialog's primary-side controllers, the iW9801 or iW9809
- Supports DCM and CCM operation
- PD-based power derating feature
- Wide  $V_{VIN}$  operating range from 2.6V to 25V
- 16-Lead QFN package

Product	Summary
---------	---------



## AC/DC Secondary-Side Controller with Integrated Synchronous Rectification for USB PD 3.0 w/PPS and Qualcomm<sup>®</sup> Quick Charge<sup>™</sup> 4+ (QC2.0/QC3.0/QC4)

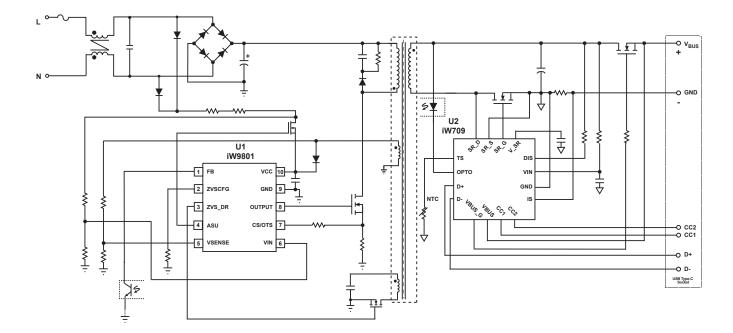


Figure 3.1 : iW709 Typical Application Circuit for Multi-Level Voltage and Current Control with ZVS Technology (Using iW9801 as ZVS-enabled Primary-Side Controller.)

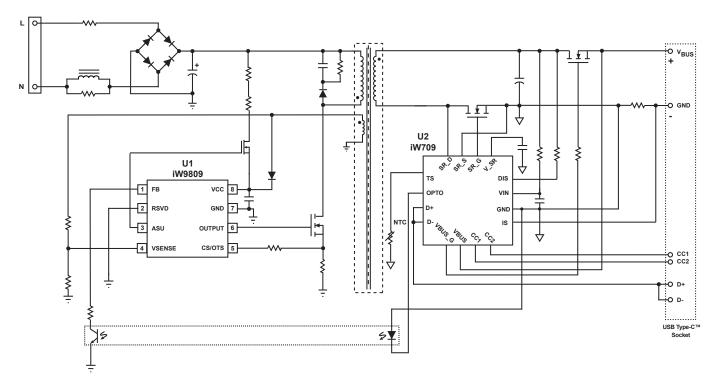


Figure 3.2 :iW709 Typical Application Circuit with Active Start-up Circuit (Using iW9809 as Primary-Side Controller. Achieving Multi-Level CV/CC Regulation and <20mW No-load Power Consumption in a Typical 25W Design)

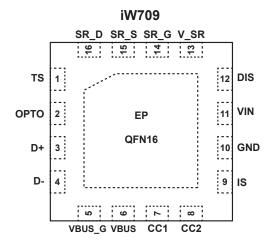
Product Summary	
-----------------	--

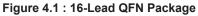
Rev. 0.31 Preliminary



AC/DC Secondary-Side Controller with Integrated Synchronous Rectification for USB PD 3.0 w/PPS and Qualcomm<sup>®</sup> Quick Charge<sup>™</sup> 4+ (QC2.0/QC3.0/QC4)

#### **4** Pinout Description





Pin No.	Pin Name	Туре	Pin Description
1	TS	Analog Input/ Output	Temperature sensing pin. Connect to an external NTC resistor to measure the power adapter temperature.
2	ОРТО	Analog Output	Optocoupler driver to transfer the output regulation control signal to primary side.
3	D+	Analog Input/ Output	USB D+ signal.
4	D-	Analog Input/ Output	USB D- signal.
5	VBUS_G	Analog Input/ Output	Gate drive for external N-FET switch.
6	VBUS	Analog Input/ Output	Connect to $V_{BUS}$ after N-FET switch.
7	CC1	Analog Input/ Output	Communication channel 1.
8	CC2	Analog Input/ Output	Communication channel 2.
9	IS	Analog Input	Output Current sensing , connect to current sensing resistor "+" terminal.
10	GND	Ground	Ground, connect to current resistor "-" terminal.
11	VIN	Power Analog Input	Input of the internal LDO and output voltage sensing circuit.
12	DIS	Analog Output	Discharging circuit. Used for fast discharging of output capacitor.
13	V_SR	Power	Voltage supply for SR drive. Connect this pin to a capacitor.
14	SR_G	Analog Output	Synchronous rectifier MOSFET driver.
15	SR_S	Analog Input	Synchronous rectifier MOSFET source input.
16	SR_D	Analog Input	Synchronous rectifier MOSFET drain voltage sensing and the Pulse Linear Regulator (PLR) input.

Product Summary

**Rev. 0.31 Preliminary** 



# AC/DC Secondary-Side Controller with Integrated Synchronous Rectification for USB PD 3.0 w/PPS and Qualcomm<sup>®</sup> Quick Charge<sup>™</sup> 4+ (QC2.0/QC3.0/QC4)

## **5 Absolute Maximum Ratings**

Absolute maximum ratings are the parameter values or ranges which can cause permanent damage if exceeded. For maximum safe operating conditions, refer to Electrical Characteristics in Section 6.

Parameter	Symbol	Value	Units
$V_{VIN}$ DC supply voltage range (I <sub>VIN</sub> = 15mA max)	V <sub>VIN</sub>	-0.3 to 30	V
Continuous DC supply current at VIN pin ( $V_{VIN}$ = 12V)	I <sub>VO</sub>	15	mA
SR_G peak output current	I <sub>G</sub>	±2	А
SR_G voltage	V <sub>G</sub>	-0.6 to 10	V
SR_D voltage (Note 1)	V <sub>D</sub>	-1.5 to 120	V
SR_D peak current	I <sub>DRAIN</sub>	-40 to 300	mA
SR_S voltage	Vs	-0.5 to 6	V
V_SR voltage	V <sub>V_SR</sub>	10	V
DIS voltage	V <sub>DIS</sub>	30	V
Peak current at DIS pin	I <sub>DIS</sub>	600	mA
OPTO voltage	V <sub>OPTO</sub>	-0.6 to 30	V
D+ voltage	V <sub>D+</sub>	-0.3 to 25	V
D- voltage	V <sub>D-</sub>	-0.3 to 25	V
CC1 voltage	V <sub>CC1</sub>	-0.3 to 25	V
CC2 voltage	V <sub>CC2</sub>	-0.3 to 25	V
IS voltage	V <sub>IS+</sub>	-0.3 to 7	V
TS voltage	V <sub>SD</sub>	-0.3 to 7	V
VBUS voltage	V <sub>VBUS</sub>	-0.7 to 30	V
VBUS_G voltage	V <sub>VBUS_G</sub>	-0.7 to 35	V
Junction temperature	TJ	-40 to 150	°C
Storage temperature		-65 to 150	°C
Thermal Resistance Junction-to-Ambient	θ <sub>JA</sub>	66.9	°C/W
ESD rating per JEDEC JS-001-2017 (CC1/CC2/D+/D- pins)		± 8,000	V
ESD rating per JEDEC JS-001-2017 (all other pins)		± 2,000	V

#### Notes:

Note 1. The DRAIN pin voltage should not be below -0.6V for more than 500ns.

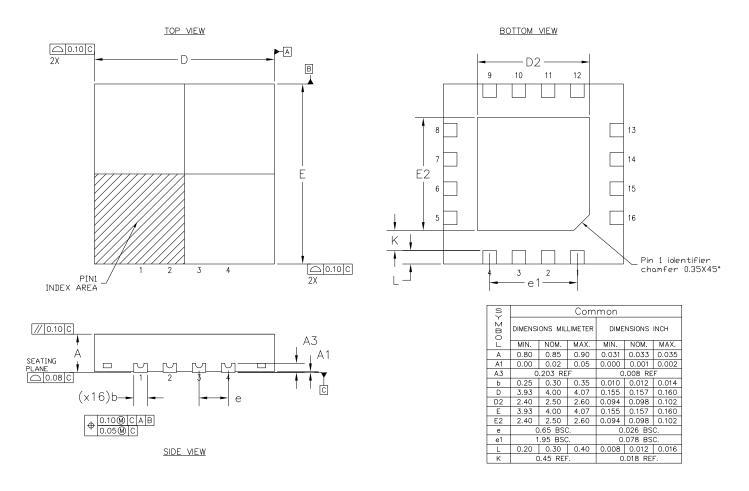
Product Summary

**Rev. 0.31 Preliminary** 

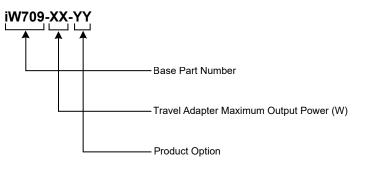


## AC/DC Secondary-Side Controller with Integrated Synchronous Rectification for USB PD 3.0 w/PPS and Qualcomm<sup>®</sup> Quick Charge<sup>™</sup> 4+ (QC2.0/QC3.0/QC4)

#### **6** Physical Dimensions



### 7 Part Number Code Description





Proc	luct	Sum	mary	
1100	uci	Juin	innai y	

Rev. 0.31 Preliminary



## AC/DC Secondary-Side Controller with Integrated Synchronous Rectification for USB PD 3.0 w/PPS and Qualcomm<sup>®</sup> Quick Charge<sup>™</sup> 4+ (QC2.0/QC3.0/QC4)

#### **Disclaimer**

Unless otherwise agreed in writing, the Dialog Semiconductor products (and any associated software) referred to in this document are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or malfunction of a Dialog Semiconductor product (or associated software) can reasonably be expected to result in personal injury, death or severe property or environmental damage. Dialog Semiconductor and its suppliers accept no liability for inclusion and/or use of Dialog Semiconductor products (and any associated software) in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

Information in this document is believed to be accurate and reliable. However, Dialog Semiconductor does not give any representations or warranties, express or implied, as to the accuracy or completeness of such information. Dialog Semiconductor furthermore takes no responsibility whatsoever for the content in this document if provided by any information source outside of Dialog Semiconductor.

Dialog Semiconductor reserves the right to change without notice the information published in this document, including, without limitation, the specification and the design of the related semiconductor products, software and applications. Notwithstanding the foregoing, for any automotive grade version of the device, Dialog Semiconductor reserves the right to change the information published in this document, including, without limitation, the specification and the design of the related semiconductor products, software and applications, in accordance with its standard automotive change notification process.

Applications, software, and semiconductor products described in this document are for illustrative purposes only. Dialog Semiconductor makes no representation or warranty that such applications, software and semiconductor products will be suitable for the specified use without further testing or modification. Unless otherwise agreed in writing, such testing or modification is the sole responsibility of the customer and Dialog Semiconductor excludes all liability in this respect.

Nothing in this document may be construed as a license for customer to use the Dialog Semiconductor products, software and applications referred to in this document. Such license must be separately sought by customer with Dialog Semiconductor.

All use of Dialog Semiconductor products, software and applications referred to in this document is subject to Dialog Semiconductor's Standard Terms and Conditions of Sale, available on the company website (www.dialog-semiconductor.com) unless otherwise stated.

Dialog, Dialog Semiconductor and the Dialog logo are trademarks of Dialog Semiconductor Plc or its subsidiaries. All other product or service names and marks are the property of their respective owners.

Qualcomm is a trademark of Qualcomm Incorporated, registered in the United States and other countries. Qualcomm Quick Charge is a trademark of Qualcomm Incorporated. All Qualcomm Incorporated marks are used with permission.

© 2020 Dialog Semiconductor. All rights reserved.

#### **RoHS Compliance**

Dialog Semiconductor's suppliers certify that its products are in compliance with the requirements of Directive 2011/65/EU of the European Parliament on the restriction of the use of certain hazardous substances in electrical and electronic equipment. RoHS certificates from our suppliers are available on request.

## **Contacting Dialog Semiconductor**

United Kingdom (Headquarters) Dialog Semiconductor (UK) LTD Phone: +44 1793 757700

Germany Dialog Semiconductor GmbH Phone: +49 7021 805-0

The Netherlands Dialog Semiconductor B.V. Phone: +31 73 640 8822

Email info\_pcbg@diasemi.com

#### North America

Dialog Semiconductor Inc. Phone: +1 408 845 8500

Japan Dialog Semiconductor K. K. Phone: +81 3 5769 5100

Taiwan Dialog Semiconductor Taiwan

Phone: +886 281 786 222

www.dialog-semiconductor.com

Hong Kong Dialog Semiconductor Hong Kong Phone: +852 2607 4271

Korea Dialog Semiconductor Korea Phone: +82 2 3469 8200 China (Shenzhen) Dialog Semiconductor China Phone: +86 755 2981 3669

China (Shanghai) Dialog Semiconductor China Phone: +86 21 5424 9058

#### Product Summary

#### Rev. 0.31 Preliminary

#### 02-Nov-2020